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Specification												
Part MC22405C6WK-BNMLW												
Number:												
Version: 1												
Date:	17/06/2011											
	Revision											
No. Date	Description Item Page											
desi	gn • manufacture • supply											

DOC.

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  - 4.2: listing out definitely the tolerance.

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- 5. The sequence of the icons is random and doesn't indicate the importance grade.
- 6. Icons explanation

Midas 2006 version logo. Midas is an integrated manufacturer of flat panel display (FPD). Midas supplies TN, HTN, STN, FSTN monochrome LCD panel; COB, COG, TAB LCD module; and all kinds of LED backlight.



### **FAST RESPONSE TIME**

This icon on the cover indicates the product is with high response speed; Otherwise not.



### PROTECTION CIRCUIT

This icon on the cover indicates the product is with protection circuit; Otherwise not.



#### **HIGH CONTRAST**

This icon on the cover indicates the product is with high contrast; Otherwise not.



#### LONG LIFE VERSION

This icon on the cover indicates the product is long life version (over 9K hours guaranteed); Otherwise not.



#### **WIDE VIEWING SCOPE**

This icon on the cover indicates the product is with wide viewing scope; Otherwise not.



#### **Anti UV VERSION**

This icon on the cover indicates the product is against UV line. Otherwise not.



#### **RoHS COMPLIANCE**

This icon on the cover indicates the product meets ROHS requirements; Otherwise not.



### **OPERATION TEMPERATURE RANGE**

This icon on the cover indicates the operating temperature range (X-Y).



### **3TIMEs 100% QC EXAMINATION**

This icon on the cover indicates the product has passed Midas thrice 100% QC.
Otherwise not.



#### TWICE SELECTION OF LED MATERIALS

This icon on the cover indicates the LED had passed Midas twice strict selection which promises the product's identical color and brightness; Otherwise not.



#### Vlcm = 3.0V

This icon on the cover indicates the product can work at 3.0V exactly; otherwise not.



#### N SERIES TECHNOLOGY (2008 developed)

New structure, new craft, new technology and new materials inside both LCD module and LCD panel to improve the "RainBow"

# **O E44627E8Y M/DPO NY**

# **Contents**

2.	General Specification	Page 4
<i>3</i> .	Module Classification Information	Page 5
<i>4</i> .	Interface Pin Function	Page 6
<i>5</i> .	Contour Drawing & Block Diagram	Page 7
6.	Function Description	Page 8
<i>7</i> .	Character Generator ROM Pattern	Page 11
8.	Instruction Table	Page 12
9.	Timing Characteristics	Page 13
<i>10</i> .	Initializing of LCM	Page 15
<i>11</i> .	Optical Characteristics	Page 17
<i>12</i> .	Absolute Maximum Rat <mark>i</mark> ngs	Page 18
<i>13</i> .	Electrical Characteristi <mark>c</mark> s	Page 18
<i>14</i> .	Backlight Information	Page 19
<i>15</i> .	Reliability	Page 20
<i>16</i> .	Inspection specification	Page 21
<i>17</i> .	Precautions in use of LCD Modules	Page 25
18.	Material List of Components for RoHs	Page 26

## 1. Specification Revision History

	RECORDS OF REVISION												
VERSION	DATE	REVISED PAGE NO.	Note										
1	2008.04.07		First issue										



## 2. General Specification

The Features of the Module is description as follow:

■ Module dimension: 118.0 x 36.0 x 13.6 (max.) mm<sup>3</sup>

■ View area: 94.5 x 16.0 mm<sup>2</sup>

Active area:  $88.3 \times 11.5 \text{ mm}^2$ 

■ Number of Characters: 24 characters x 2 Lines

■ Dot size:  $0.6 \times 0.65 \text{ mm}^2$ 

■ Dot pitch:  $0.65 \times 0.70 \text{ mm}^2$ 

■ Character size: 3.2 x 5.55 mm<sup>2</sup>

■ Character pitch: 3.7 x 5.95 mm<sup>2</sup>

■ LCD type: STN, Negative, Transmissive, blue

■ Duty: 1/16

■ View direction: 6 o'clock

■ Backlight Type: LED White

design • manufacture • supply

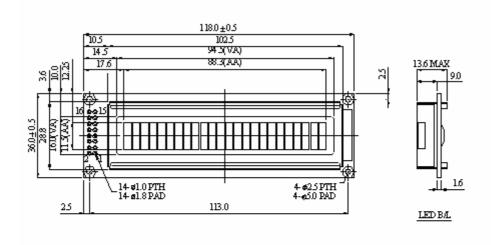
### **Midas LCD Part Number System**

```
COG
                 132033
                                                                                  S
                                 Α
                                               6
                                                                                                 Т
                                                                                                        L
          2
                       3
                                 4
                                        5
                                               6
                                                      7
                                                             8
                                                                    9
                                                                                 10
                                                                                        11
                                                                                                12
                                                                                                       13
 1
                                                                                                              14
                                                                                                                      15
                                                                                                                             16
         =
                   MC: Midas Components
                   Blank: COB (chip on board) COG: chip on glass
                   No of dots
                                      (e.g. 240064 = 240 \times 64 \text{ dots})
                                                                             (e.g. 21605 = 2 \times 165 mm C.H.)
3
         =
         =
                   Series
4
         =
                   Series Variant:
                                       A to Z - see addendum
                                                          9: 9 o'clock
                                                                             12: 12 o'clock
         =
                   3: 3 o'clock
                                      6: 6 o'clock
6
                   S: Normal (0 to + 50 deg C) W: Wide temp. (-20 to + 70 deg C) X: Extended temp (-30 + 80 Deg C)
7
         =
8
                   Character Set
                   Blank: Standard (English/Japanese)
                   C: Chinese Simplified (Graphic Displays only)
                   CB: Chinese Big 5 (Graphic Displays only)
                   H: Hebrew
                   K: European (std) (English/German/French/Greek)
                   L: English/Japanese (special)
                   M: European (English/Scandinavian)
                   R: Cyrillic
                   W: European (English/Greek)
                   U: European (English/Scandinavian/Icelandic)
         =
                   Bezel Height (where applicable /available)
                                                       LED Connection
                              Top of Bezel to Top
                                                                               Array or
                                                      Common (via pins 1
                                    of PCB
                                                                               Edge Lit
                                                             and 2)
                             9.5mm / not
                    Blank
                                                        via pins 15+ 16-
                                                                                 Array
                             applicable
                    2
                             8.9 \; \mathrm{mm}
                                                            Common
                                                                                 Array
                    3
                             7.8 \; \mathrm{mm}
                                                            Separate
                                                                                 Array
                    4
                             7.8 \text{ mm}
                                                            Common
                                                                                 Array
                    5
                            9.5 \text{ mm}
                                                            Separate
                                                                                 Array
                    6
                             7~\mathrm{mm}
                                                            Common
                                                                                 Array
                    7
                             7 \text{ mm}
                                                            Separate
                                                                                 Array
                    8
                                                            Common
                             6.4 \text{ mm}
                                                                                 Edge
                             6.4 \text{ mm}
                                                            Separate
                                                                                 Edge
                             5.5 \text{ mm}
                                                            Common
                                                                                 Edge
                    A
                    В
                             5.5 \text{ mm}
                                                            Separate
                                                                                 Edge
                    D
                             6.0 mm
                                                            Separate
                                                                                 Edge
                    E
                             5.0mm
                                                            Separate
                                                                                 Edge
                    \mathbf{F}
                             4.7mm
                                                            Common
                                                                                 Edge
                    \mathbf{G}
                             3.7mm
                                                            Separate
                                                                                  \mathbf{EL}
                             7 \text{ mm}
                                                            Separate
                                                                                 Edge
                   T: TN S: STN B: STN Blue G: STN Grey F: FSTN F2: FFSTN V: VA (Vertically Aligned)
10
11
         =
                   P: Positive N: Negative
12
                   R: Reflective M: Transmissive T: Transflective
         =
                   Backlight: Blank: Reflective L: LED
13
         =
                   Backlight Colour: Y: Yellow-Green W: White B: Blue R: Red A: Amber O: Orange G: Green RGB: R.G.B.
14
                   Driver Chip:
                                      Blank: Standard I: I<sup>2</sup>C S: SPI T: Toshiba T6963C A: Avant SAP1024B
                                                                                                                      R: Raio RA6963
15
         =
                   Voltage Variant: e.g. 3 = 3v
16
         =
```

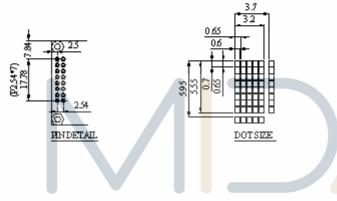
## 4. Interface Pin Function

Pin No.	Symbol	Level	Description							
1	$V_{SS}$	0V	Ground							
2	$V_{ m DD}$	5.0V	Supply Voltage for logic							
3	VO	(Variable)	Operating voltage for LCD							
4	RS	H/L	H: DATA, L: Instruction code							
5	R/W	H/L	H: Read(MPU→Module) L: Write(MPU→Module)							
6	Е	Н,Н→L	Chip enable signal							
7	DB0	H/L	Data bus line							
8	DB1	H/L	Data bus line							
9	DB2	H/L	Data bus line							
10	DB3	H/L	Data bus line							
11	DB4	H/L	Data bus line							
12	DB5	H/L	Data bus line							
13	DB6	H/L	Data bus line							
14	DB7	H/L	Data bus line							
15	A	_	Power supply for LED backlight (+)							
16	K	ian •	Power supply for LED backlight ( - )							

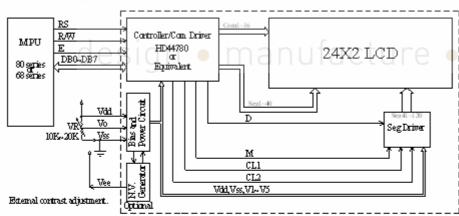
## 5. Contour Drawing & Block Diagram



MM NO.	SYMBOL.
1	Vss
2	Vdd
3	Vo
4	RS
5	R∕W
6	E
7	DB0
8	DB1
9	DB2
10	DB3
11	DB4
12	DB5
13	DB6
14	DB7
15	A
16	K



The non-specified tolerance of dimension is  $\pm 0.3$ mm.



Character located 1 2 3 4 5 6 ----- 19 20 21 22 23 24 DDRAM address 00 01 02 03 04 05 ----- 12 13 14 15 16 17 DDRAM address 40 41 42 43 44 45 ----- 52 53 54 55 56 57

### 6. Function Description

The LCD display Module is built in a LSI controller, the controller has two 8-bit registers, an instruction register (IR) and a data register (DR).

The IR stores instruction codes, such as display clear and cursor shift, and address information for display data RAM (DDRAM) and character generator (CGRAM). The IR can only be written from the MPU. The DR temporarily stores data to be written or read from DDRAM or CGRAM. When address information is written into the IR, then data is stored into the DR from DDRAM or CGRAM. By the register selector (RS) signal, these two registers can be selected.

RS	R/W	Operation
0	0	IR write as an internal operation (display clear, etc.)
0	1	Read busy flag (DB7) and address counter (DB0 to DB7)
1	0	Write data to DDRAM or CGRAM (DR to DDRAM or CGRAM)
1	1	Read data from DDRAM or CGRAM (DDRAM or CGRAM to DR)

### **Busy Flag (BF)**

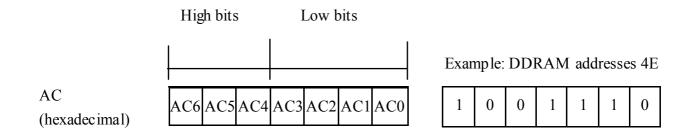
When the busy flag is 1, the controller LSI is in the internal operation mode, and the next instruction will not be accepted. When RS=0 and R/W=1, the busy flag is output to DB7. The next instruction must be written after ensuring that the busy flag is 0.

Address Counter (AC) — Manufacture — Supply

The address counter (AC) assigns addresses to both DDRAM and CGRAM.

### **Display Data RAM (DDRAM)**

This DDRAM is used to store the display data represented in 8-bit character codes. Its extended capacity is 80×8 bits or 80 characters. Below figure is the relationships between DDRAM addresses and positions on the liquid crystal display.



### Display position DDRAM address

	1	2	3	4	3	0	/	 • • • • •	 	• • • •	21	22	23	24
1	00	01	02	03	04	05	06				14	15	16	17
Г	10	11	42	42	4.4	4.5	1.0				<i>E</i> 1		5.0	-7

2-Line by 24-Character Display

### **Character Generator ROM (CGROM)**

The CGROM generate 5×8 dot or 5×10 dot character patterns from 8-bit character codes. See Table 2.

### **Character Generator RAM (CGRAM)**

In CGRAM, the user can rewrite character by program. For  $5\times8$  dots, eight character patterns can be written, and for  $5\times10$  dots, four character patterns can be written.

Write into DDRAM the character code at the addresses shown as the left column of table 1. To show the character patterns stored in CGRAM.



### Relationship between CGRAM Addresses, Character Codes (DDRAM) and Character patterns

Table 1.

For 5 \* 8 dot character patterns

3 8 doi character patter	11.5
Character Codes (DDRAM data)	CGRAM Address Character Patterns (CGRAM data)
7 6 5 4 3 2 1 0	5 4 3 2 1 0 7 6 5 4 3 2 1 0
High Low	High Low High Low
0 0 0 0 * 0 0 0	0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0
	0 0 1
0 0 0 0 * 1 1 1	
5 * 10 dot character patte:	rns
Character Codes	Character Patterns

For 5

To dot character pat	IC II	13		
Character Codes (DDRAM data)		CGRAM Address		Character Patterns (CGRAM data)
7 6 5 4 3 2 1 0 High Low		5 4 3 2 1 0 H igh Low	9 (	7 6 5 4 3 2 1 0 High Low
0 0 0 0 * 0 0 0		0 0 0 0 0 0 0 0 0 0 0 0 1 0 0 1 0 0 0 1 1 0 0 0 0 1 0 0 0 0 0 1 0 0 1 0 1 0 1 0 0 0 0 1 1 1 1 1 1 0 0 0 0 1 1 0 0 0 1 1 0 0 0 1 1 0 0 0 1 1 0 0 0 1 1 0 0 0 1 1 0 0 0 1 1 0 0 0 1 1 0 0 0 1 1 0 0 0 1 1 0 0 0 0 1 1 0 0 0 0 1 1 0		* * * * 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0
		1 1 1 1		* * * * * * *

■ : " High "

## 7. Character Generator ROM Pattern

Table 2.

Upper 4 bit Lower 4 bit				LLHH	LHLL	LHLH		LHHH		HLLH			HHLL	ННГН	НННЬ	нннн
LLLL	CG RAM (1)						11	3 1 1 1 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2		assa Sana Sansa	.#.` -#!\{ -#!\{	×	1	╸╸ ┇╸╮┍┇ ┇		•••• ••••
LLLH	CG RAM (2)				2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2	# , # # , # *#*.	151 1158 -1188		դ պ ∄ ∰ * <i>բբ</i> Դֆ		n" Ng ng	*				<u>.</u>
LLHL	CG RAM (3)			Agama Pa Agama Agama	lana" lana" lana			},""	# # # # # # # # # # # # # # # # # # #	inin Linin	,,\ # <mark>}</mark> ,#\{ #\{	- B	8 <b>, 8 , 8</b>		Jan Jan K	
LLHH	CG RAM (4)		n∦n∦r nÿn∦n		BEER'S	uuu u uuu e eeeee		anam gana gana	tuf unuş unuş	# <sup>™</sup> n nnn H mnn	," 1,,}	•,			Ann Jana Jana	
LHLL	CG RAM (5)							[##				nª		ej pipi Pi Pi Pi aipr ainepine		
LHLH	CG RAM (6)			Para P	Fann Fanns			}	**************************************			i n'a				
LHHL	CG RAM (7)	**************************************		6	inna Inna I			1,,,1	À	****         		<b>B B</b> _	• • [ •			
LHHH	CG RAM (8)								)               			** *** ** **		3 H 3 H 1 H	1	
HLLL	CG RAM (1)									THE REE	7	N N N N N N N	a į	g sang 	<b>]</b> -:	
HLLH	CG RAM (2)			I THE	7			1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	n n Jasa Pasa Pasa Pan		- -	, 1, 1, 1, 1, 1, 1, 1, 1, 1, 1, 1, 1, 1,			,***,	
HLHL	CG RAM (3)	n" n" n" n"	**			umang u <sup>a</sup> n Baanu	<b>.</b> , ]	11181 12181	**************************************		farri Farri Farri	PALLE Par Par Par Par Par Par Par Par Par Par		ngmmm ng ng ngamm	<b> 1</b> ,	
НЦНН	CG RAM (4)		raBaa T	135 174		ju i i		, 10 mm	n/Bra.	~**\ * ***** ******	**************************************	1 12 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1		M SE SE SESSE SE SE SE SE SE SE SE SE SE	} _ ~**	- 4 
HHLL	CG RAM (5)	MA A AM	<b>4</b>	" <sub>***</sub> *			111			, "", "   "					, 3 m.	
ннгн	(6)	a" a "a	11111	1222				***					**	picapi pi picapi pigi piga picapi pigi piga picapi pi		****
НННЬ	CG RAM (7)		###	***		n <sup>n</sup> n,		1 " 1 <sub>3</sub> 1	n n n <sup>n</sup> n nnng			] 10 1 1 1 1 1 1 1			land land	
нннн	CG RAM (8)		, , , , , ,				,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,	i b Innal	, ", , 25. } 1 1 1 1 }	n n n n	n ng ti ng ilin		, 3 <sup>1</sup> 4 3	, , , , , , , , , , , , , , , , , , ,	, <u></u>	

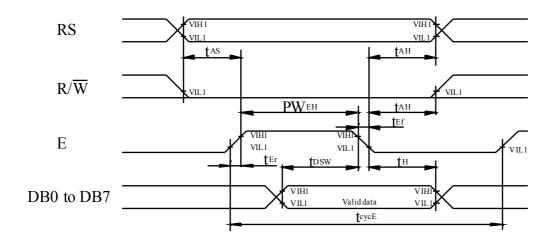
## 8. Instruction Table

Instruction				Ins	structi	ion Co	de				Description	Execution time
Thstruction	RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	-	(fosc=270Khz)
Clear Display	0	0	0	0	0	0	0	0	0	1	Write "00H" to DDRAM and set DDRAM address to "00H" from AC	1.53ms
Retum Home	0	0	0	0	0	0	0	0	1	l	Set DDRAM address to "00H" from AC and return cursor to its original position if shifted. The contents of DDRAM are not changed.	1.53ms
Entry Mode Set	0	0	0	0	0	0	0	1	I/D	SH	Assign cursor moving direction and enable the shift of entire display.	39 μ s
Display ON/OFF Control	0	0	0	0	0	0	1	D	С	В	Set display (D), cursor (C), and blinking of cursor (B) on/off control bit.	39 μ s
Cursor or Display Shift	0	0	0	0	0	1	S/C	R/L	_	_	Set cursor moving and display shift control bit, and the direction, without changing of DDRAM data.	39 μ s
Function Set	0	0	0	0	1	DL	N	F			Set interface data length (DL:8-bit/4-bit), numbers of display line (N:2-line/1-line)and, display font type (F:5×11 dots/5×8 dots)	39 μ s
Set CGRAM Address	0	0	0	1	AC5	AC4	AC3	AC2	AC1	AC0	Set CGRAM address in address counter.	39 μ s
Set DDRAM Address	0	0	1	AC6	AC5	AC4	AC3	AC2	AC1	AC0	Set DDRAM address in address counter.	39 μ s
Read Busy Flag and Address	0	1   e	BF S I (	AC6	AC5	AC4	AC3	AC2	AC1	AC0	Whether during internal operation or not can be known by reading BF. The contents of address counter can also be read.	0 μ s
Write Data to RAM	1	0	D7	D6	D5	D4	D3	D2	D1	D0	Write data into internal RAM (DDRAM/CGRAM).	43 μ s
Read Data from RAM	1	1	D7	D6	D5	D4	D3	D2	D1	D0	Read data from internal RAM (DDRAM/CGRAM).	43 μs

\* "-": don't care

# **9. Timing Characteristics**

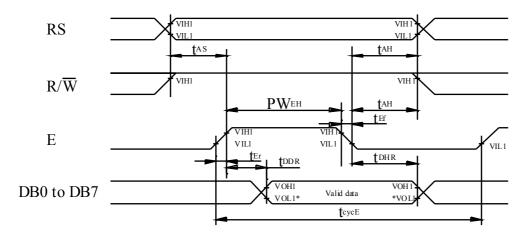
## 9.1 Write Operation



Ta=25°C, VDD=5.0± 0.5V

					- /
Item	Symbol	Min	Тур	Max	Unit
Enable cycle time	$t_{\rm cycE}$	1200	_		ns
Enable pulse width (high level)	$PW_{EH}$	140	_		ns
Enable rise/fall time	$t_{\rm Er}$ , $t_{\rm Ef}$	a <u>c</u> tt	ur <u>e</u>	25	ooty <sub>ns</sub>
Address set-up time (RS, R/W to E)	$t_{AS}$	0	_	_	ns
Address hold time	$t_{ m AH}$	10		_	ns
Data set-up time	$t_{ m DSW}$	40	_	_	ns
Data hold time	$t_{\mathrm{H}}$	10	_	_	ns

## 9.2 Read Operation

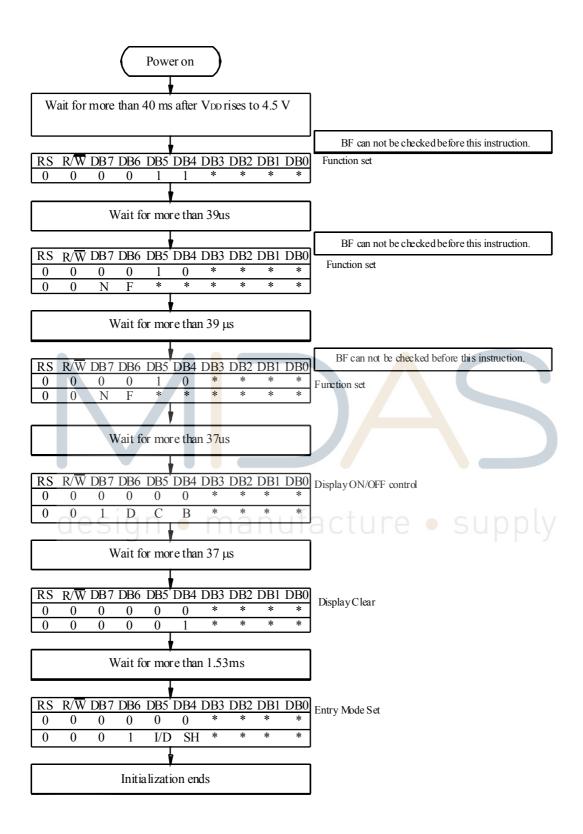


NOTE: \*VOL1 is assumed to be 0.8V at 2 MHZ operation.

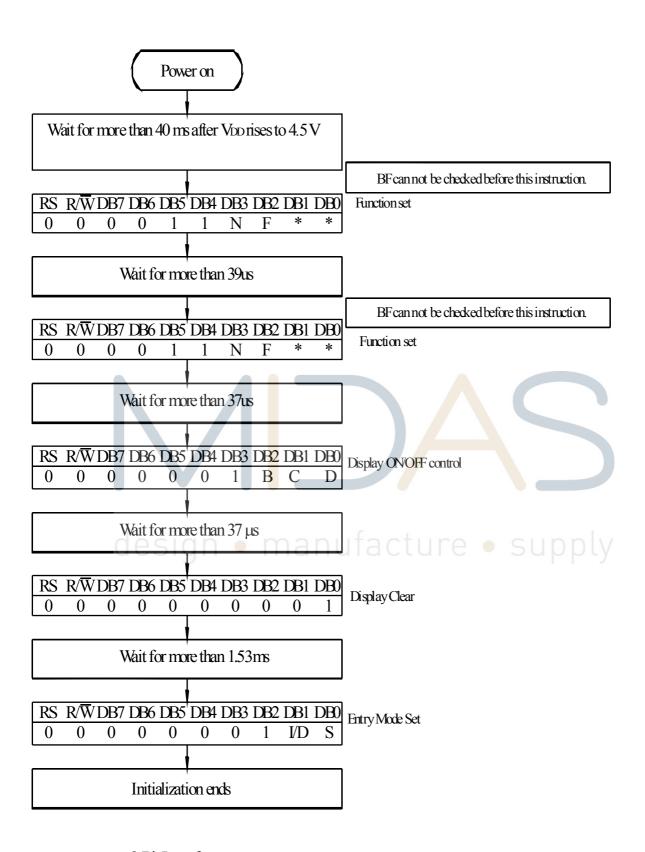
Ta=25°C, VDD=5.0 $\pm$  0.5V

Item	Symbol	Min	Тур	Max	Unit
Enable cycle time	$t_{\rm cycE}$	1200			ns
Enable pulse width (high level)	$PW_{EH}$	140	_	_	ns
Enable rise/fall time	$t_{\rm Er}, t_{\rm Ef}$	_	_	25	ns
Address set-up time (RS, R/W to E)	$t_{AS}$	0	_	-	ns
Address hold time	t <sub>AH</sub>	10	пе	5 U	ns
Data delay time	t <sub>DDR</sub>	_	_	100	ns
Data hold time	$t_{\mathrm{DHR}}$	10	_	_	ns

## 10. Initializing of LCM



4-Bit Ineterface



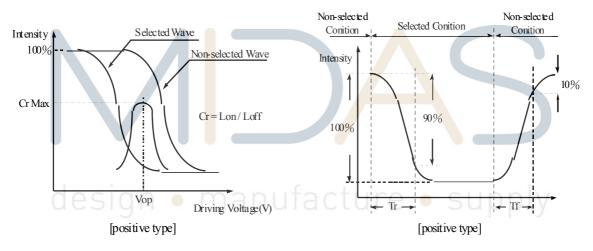
8-Bit Ineterface

## 11. Optical Characteristics

Item	Symbol	Condition	Min	Тур	Max	Unit
View Angle	(V) θ	CR≧2	20	_	40	deg
view ringie	$(H) \varphi$	CR≧2	-30	_	30	deg
Contrast Ratio	CR	_	_	3	_	_
Response Time	T rise	_	_	200	300	ms
1	T fall	_	_	200	300	ms

### **Definition of Operation Voltage (Vop)**

### Definition of Response Time (Tr, Tf)

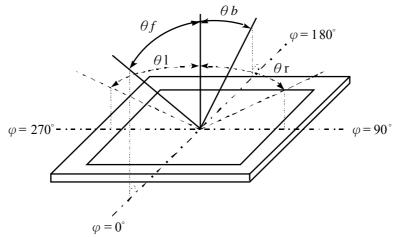


### **Conditions:**

Operating Voltage: Vop Viewing Angle( $\theta$ ,  $\phi$ ):  $0^{\circ}$ ,  $0^{\circ}$ 

Frame Frequency: 64 HZ Driving Waveform: 1/N duty, 1/a bias

### Definition of viewing angle ( $CR \ge 2$ )



Page 17, Total 28 Pages

# 12. Absolute Maximum Ratings

Item	Symbol	Min	Тур	Max	Unit
Operating Temperature	$T_{\mathrm{OP}}$	-20	_	+70	$^{\circ}\!\mathbb{C}$
Storage Temperature	$T_{ST}$	-30	_	+80	$^{\circ}\!\mathbb{C}$
Input Voltage	$V_{\rm I}$	$V_{SS}$	_	$V_{\mathrm{DD}}$	V
Supply Voltage For Logic	$V_{ m DD} ext{-}V_{ m SS}$	-0.3	_	7	V
Supply Voltage For LCD	$ m V_{DD} ext{-}V_0$	-0.3	_	13	V

## 13. Electrical Characteristics

Item	Symbol	Condition	Min	Тур	Max	Unit
Supply Voltage For Logic	$V_{\rm DD}$ - $V_{\rm SS}$	-	4.5	5.0	5.5	V
		Ta=-20°C	_	_	5.5	V
Supply Voltage For LCD	$V_{\rm DD}$ - $V_0$	Ta=25°C	_	4.5	_	V
		Ta=+70°C	3.8	_		V
Input High Volt.	V <sub>IH</sub>	nufac:	$0.7~V_{DD}$		$V_{\mathrm{DD}}$	V
Input Low Volt.	$V_{\mathrm{IL}}$	Hulac	$V_{SS}$	_ 5	0.6	UVV
Output High Volt.	$V_{\mathrm{OH}}$	_	3.9	_	_	V
Output Low Volt.	$V_{\mathrm{OL}}$	_	_	_	0.4	V
Supply Current	$I_{DD}$	$V_{DD}=5V$	1.0	1.2	1.5	mA

## 14. Backlight Information

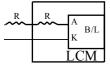
### **Specification**

PARAMETER	SYMBOL	MIN	ТҮР	MAX	UNIT	TEST CONDITION	
Supply Current	ILED	28.8	32	50	mA	V=3.5V	
Supply Voltage	V	3.4	3.5	3.6	V		
Reverse Voltage	VR		5	1	${f v}$		
<b>Luminous Intensity</b>	IV	210	230		CD/M <sup>2</sup>	ILED=32mA	
Wave Length	λр				nm	ILED=32mA	
Life Time			50K	-	Hr.	ILED=32mA	
Color		White					

Note: The LED of B/L is drive by current only, drive voltage is for reference only. drive voltage can make driving current under safety area (current between minimum and maximum).



2.D rive from pin 15, pin 16



ill never get Vee output from pin 15)

## 15. Reliability

Content of Reliability Test (wide temperature, -20℃ ~70℃)

En vironmental Test							
Test Item	Content of Test	Test Condition	Note				
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80°C 200hrs	2				
Low Temperature storage	Endurance test applying the high storage temperature for a long time.	-30℃ 200hrs	1,2				
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	200hrs					
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20°C 200hrs	1				
High Temperature/ Humidity Operation	The module should be allowed to stand at 60°C ,90%RH max For 96hrs under no-load condition excluding the polarizer, Then taking it out and drying it at normal temperature.	60°C ,90%RH 96hrs	1,2				
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation  -20°C 25°C 70°C  30min 5min 30min 1 cycle	-20°C/70°C 10 cycles					
Wibration test	Endurance test applying the vibration during transportation and using.	Total fixed amplitude: 15mm  Vibration Frequency: 10~55Hz  One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes					
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=800V,RS=1.5kΩ CS=100pF 1 time					

Note1: No dew condensation to be observed.

Note2: The function test shall be conducted after 4 hours storage at the normal Temperature and humidity after remove from the test chamber.

Note3: Vibration test will be conducted to the product itself without putting it in a container.

# 16. Inspection specification

NO	Item	Criterion					
01	Electrical Testing	<ol> <li>1.1 Missing vertical, horizontal segment, segment contrast defect.</li> <li>1.2 Missing character, dot or icon.</li> <li>1.3 Display malfunction.</li> <li>1.4 No function or no display.</li> <li>1.5 Current consumption exceeds product specifications.</li> <li>1.6 LCD viewing angle defect.</li> <li>1.7 Mixed product types.</li> <li>1.8 Contrast defect.</li> </ol>					
02	Black or white spots on LCD (display only)	<ul> <li>2.1 White and black spots on display ≤0.25mm, no more than three white or black spots present.</li> <li>2.2 Densely spaced: No more than two spots or lines within 3mm</li> </ul>	2.5				
03	LCD black spots, white spots, contamination	3.1 Round type : As following drawing $\Phi=(\mathbf{x}+\mathbf{y})/2$ $X$ $Y$	2.5				
	(non-display)	3.2 Line type : (As following drawing)  Length Width Acceptable Q TY  W $\leq 0.02$ Accept no dense  L $\leq 3.0$ $0.02 < W \leq 0.03$ $0.03 < W \leq 0.05$ As round type	2.5				
04	Polarizer bubbles	If bubbles are visible, judge using black spot specifications, not easy to find, must check in specify direction. $ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	2.5				

NO Item Criterion AQI 05 Scratches Follow NO.3 LCD black spots, white spots, contamination
Symbols Define: x: Chip length x: Chip length y: Chip width t: Glass thickness a: LCD side length t: Electrode pad length: 6.1 General glass chip: 6.1.1 Chip on panel surface and crack between panels:    Z

NO	Item	Criterion	AQL
07	Cracked glass	The LCD with extensive crack is not acceptable.	2.5
08	Backlight elements	<ul> <li>8.1 Illumination source flickers when lit.</li> <li>8.2 Spots or scratched that appear when lit must be judged. Using LCD spot, lines and contamination standards.</li> <li>8.3 Backlight doesn't light or color wrong.</li> </ul>	0.65 2.5 0.65
09	Bezel	9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination.  9.2 Bezel must comply with job specifications.	2.5 0.65
10	PCB · COB	<ul> <li>10.1 COB seal may not have pinholes larger than 0.2mm or contamination.</li> <li>10.2 COB seal surface may not have pinholes through to the IC.</li> <li>10.3 The height of the COB should not exceed the height indicated in the assembly diagram.</li> <li>10.4 There may not be more than 2mm of sealant outside the seal area on the PCB. And there should be no more than three places.</li> <li>10.5 No oxidation or contamination PCB terminals.</li> <li>10.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts.</li> <li>10.7 The jumper on the PCB should conform to the product characteristic chart.</li> <li>10.8 If solder gets on bezel tab pads, LED pad, zebra pad or screw hold pad, make sure it is smoothed down.</li> <li>10.9 The Scraping testing standard for Copper Coating of PCB</li> </ul>	2.5 2.5 0.65 2.5 2.5 0.65 2.5 2.5 2.5
11	Soldering	11.1 No un-melted solder paste may be present on the PCB. 11.2 No cold solder joints, missing solder connections, oxidation or icicle. 11.3 No residue or solder balls on PCB. 11.4 No short circuits in components on PCB.	2.5 2.5 2.5 0.65

NO	Item	Criterion	AQL
12	General app earance	<ul> <li>12.1 No oxidation, contamination, curves or, bends on interface Pin (OLB) of TCP.</li> <li>12.2 No cracks on interface pin (OLB) of TCP.</li> <li>12.3 No contamination, solder residue or solder balls on product.</li> <li>12.4 The IC on the TCP may not be damaged, circuits.</li> <li>12.5 The uppermost edge of the protective strip on the interface pin must be present or look as if it cause the interface pin to sever.</li> <li>12.6 The residual rosin or tin oil of soldering (component or chip component) is not burned into brown or black color.</li> <li>12.7 Sealant on top of the ITO circuit has not hardened.</li> <li>12.8 Pin type must match type in specification sheet.</li> <li>12.9 LCD pin loose or missing pins.</li> <li>12.10 Product packaging must the same as specified on packaging specification sheet.</li> <li>12.11 Product dimension and structure must conform to product specification sheet.</li> </ul>	2.5 0.65 2.5 2.5 2.5 2.5 0.65 0.65 0.65

## 17. Precautions in use of LCD Modules

- (1) Avoid applying excessive shocks to the module or making any alterations or modifications to it.
- (2)Don't make extra holes on the printed circuit board, modify its shape or change the components of LCD module.
- (3)Don't disassemble the LCM.
- (4)Don't operate it above the absolute maximum rating.
- (5)Don't drop, bend or twist LCM.
- (6) Soldering: only to the I/O terminals.
- (7)Storage: please storage in anti-static electricity container and clean environment.

## 18. Material List of Components for RoHs

1. T aaæ AÔ[ { ] [ } ^ } • Ltd. hereby declares that all of or part of products, including, but not limited to, the LCM, accessories or packages, manufactured and/or delivered to your company (including your subsidiaries and affiliated company) directly or indirectly by our company (including our subsidiaries or affiliated companies) do not intentionally contain any of the substances listed in all applicable EU directives and regulations, including the following substances.

Exhibit A: The Harmful Material List

Material	(Cd)	(Pb)	(Hg)	(Cr6+)	PBBs	PBDEs			
Limited Value	100 ppm	1000 ppm	1000 ppm	1000 ppm	1000 ppm	1000 ppm			
Above limit	Above limited value is set up according to RoHS.								

### 2.Process for RoHS requirement:

- (1) Use the Sn/Ag/Cu soldering surface; the surface of Pb-free solder is rougher than we used before.
- (2) Heat-resistance temp.:

Reflow: 250°C,30 seconds Max.;

Connector soldering wave or hand soldering : 320°C, 10 seconds max.

(3) Temp. curve of reflow, max. Temp. : 235±5°C;

Recommended customer's soldering temp. of connector: 280°C, 3 seconds